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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/692,430	10/23/2003	Roger W. Lindsay	400.263US01	8403	
27073 1 EEEEDT IAN	7590 01/17/2007 Z & POLGLAZE, P.A.		EXAM	EXAMINER	
P.O. BOX 5810	009		400.263US01 8403 EXAMINER LUU, CHUONG A ART UNIT PAPER NUMBER 2818 DELIVERY MODE	UONG A	
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SHORTENED STATUTOR	Y PERIOD OF RESPONSE	MAIL DATE	DELIVER	Y MODE	
3 MO	NTHS	01/17/2007	PÁPER		

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

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	Application No.	Applicant(s)				
	10/692,430	LINDSAY, ROGER W.				
Office Action Summary	Examiner	Art Unit				
	Chuong A. Luu	2818				
The MAILING DATE of this communication Period for Reply	appears on the cover sheet wit	h the correspondence address				
A SHORTENED STATUTORY PERIOD FOR RETHE MAILING DATE OF THIS COMMUNICATION - Extensions of time may be available under the provisions of 37 CF after SIX (6) MONTHS from the mailing date of this communication. If the period for reply specified above is less than thirty (30) days, a lif NO period for reply is specified above, the maximum statutory period for reply within the set or extended period for reply will, by so Any reply received by the Office later than three months after the nearned patent term adjustment. See 37 CFR 1.704(b).	DN. R 1.136(a). In no event, however, may a re n. a reply within the statutory minimum of thirty riod will apply and will expire SIX (6) MONT tatute, cause the application to become ABA	ply be timely filed (30) days will be considered timely. 'HS from the mailing date of this communic NDONED (35 U.S.C. § 133).	ation:			
Status						
1) Responsive to communication(s) filed on 2	26 October 2006.					
<u> </u>	This action is non-final.					
	·-					
Disposition of Claims						
4) Claim(s) <u>1-28 and 42-62</u> is/are pending in 4a) Of the above claim(s) is/are with		·				
5)⊠ Claim(s) <u>9-28 and 42-62</u> is/are allowed.	•					
6)⊠ Claim(s) <u>1-4 and 8</u> is/are rejected.						
7)⊠ Claim(s) <u>5-7</u> is/are objected to.						
8) Claim(s) are subject to restriction ar	nd/or election requirement.					
Application Papers						
9) The specification is objected to by the Exan	niner.					
10) The drawing(s) filed on is/are: a)	accepted or b) objected to b	y the Examiner.				
Applicant may not request that any objection to	the drawing(s) be held in abeyand	e. See 37 CFR 1.85(a).				
Replacement drawing sheet(s) including the co	rrection is required if the drawing(s	s) is objected to. See 37 CFR 1.12	21(d).			
11)☐ The oath or declaration is objected to by the	Examiner. Note the attached	Office Action or form PTO-152	2.			
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of: 1. Certified copies of the priority docum		119(a)-(d) or (f).				
2. Certified copies of the priority docum		unlication No				
3. Copies of the certified copies of the			;			
application from the International Bu		•				
* See the attached detailed Office action for a	list of the certified copies not r	eceived.				
Attachment(s)						
Notice of References Cited (PTO-892)	4) 🗍 Interview St	ımmary (PTO-413)				
P) Denotice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)	/Mail Date				
 Information Disclosure Statement(s) (PTO-1449 or PTO/SB Paper No(s)/Mail Date 	5) Notice of Inf 6) Other:	ormal Patent Application (PTO-152)				

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DETAILED ACTION

Response to Arguments

Applicant's arguments with respect to claims 1-4 and 8 have been considered but are most in view of the new ground(s) of rejection.

PRIOR ART REJECTIONS

Statutory Basis

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

The Rejections

Claims 1-4 and 8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Spadea (U.S. 7,075,140) in view of Chang (U.S. 5,687,118).

Spadea discloses a non-volatile memory array with

(1) forming a source slot and a drain contact region at opposite ends of a NAND string disposed on a substrate of the memory array, the NAND string comprising a plurality of memory cells connected in series between a source select gate and a drain select gate, wherein a portion of the drain contact region is formed directly over the

drain select gate and wherein the single mask defines areas for exposing the substrate (see column 12, lines 19-23. Figure 7B);

- (2) further comprising, before forming the source slot and the drain contact region, forming a dielectric layer on the substrate, the NAND string, and source and drain select gates (see column 12, lines 19-23. Figure 7B);
- (3) further comprising aligning the drain contact region to a sidewall of the drain select gate (see Figure 7B);
- (4) wherein forming the source slot and the drain contact region comprises removing the dielectric layer from the substrate (see Figure 7B);
- (8) further comprising aligning the source slot to a sidewall of the source select gate (see Figure 7B);

Spadea teaches the above claimed invention except for using a single mask.

However, Chang discloses a memory cell with (1).. using a single mask (see column 12, lines 49-52). Therefore, it It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the teaching of Spadea (accordance with the teaching of Chang). Doing so would facilitate the manufacture of the semiconductor device and increase the speed of the semiconductor structure.

Allowable Subject Matter

Claims 5-7 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

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Claims 9-28 and 42-62 are allowed.

The following is an examiner's statement of reasons for allowance: The examiner has reviewed the prior art in light of applicant's claimed invention and finds that the combined claims define over the prior art. The cited prior art does not disclose or suggest a semiconductor memory transistor inter alia the limitations "...forming a drain select gate overlying the substrate and adjacent a drain of a last floating-gate transistor of the plurality of serially-connected floating-gate transistors, a source of the drain select gate coupled to a drain of the last floating-gate transistor; forming a first layer of dielectric material overlying the source select gate, the NAND string, the drain select gate, and exposed surfaces of the substrate adjacent the source and drain select gates; forming a second layer of dielectric material overlying the first layer of dielectric material, wherein the second layer of dielectric material comprises a dielectric material different from the first layer of dielectric material; patterning the second layer of dielectric material to expose portions of the first layer of dielectric material adjacent the source select gate, adjacent the drain select gate and overlying the drain select gate to thereby define a source slot and a drain contact region substantially concurrently; removing exposed portions of the first layer of dielectric material adjacent the source select gate and adjacent the drain select gate, thereby exposing portions of the substrate adjacent the source select gate and the drain select; forming a first layer of conductive material overlying the second layer of dielectric material and in contact with the exposed portions of the substrate; removing an upper portion of the first layer of conductive material to recess it below a surface of the second layer of dielectric

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material, thereby leaving a first portion of the first layer of conductive material in the source slot and a second portion of the first layer of conductive material in the drain contact region; substantially concurrently forming a source line coupled to the first portion of the first layer of conductive material and a drain contact coupled to the second portion of the first layer of conductive material; forming a third layer of dielectric material overlying the second layer of dielectric material, the source line, and the drain contact; forming a bit line contact through the third layer of dielectric material and coupled to a portion of the drain contact overlying the drain select gate..."

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Chuong A. Luu whose telephone number is (571) 272-1902. The examiner can normally be reached on M-F (6:15-2:45).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew Smith can be reached on (571) 272-1907. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Chuong Anh Luu Patent Examiner January 05, 2007

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